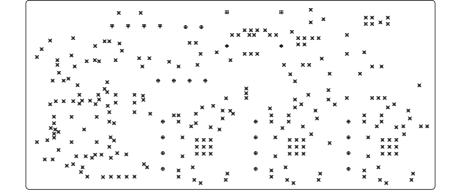


Layer	Name	Material	Thickness	Constant	Gerber	Board Layer Stack
	Top Overlay				GTO	
	Top Solder	Solder Resist	0.010mm	3.5	GTS	
1	Top Layer		0.035mm		GTL	
	Dielectric1	FR-4 (7628)	0.099mm	4.2		
2	MidLayer1		0.018mm		G1	
	Core		1.265mm	4.2		
3	MidLayer2		0.018mm		G2	
	Dielectric 4	FR-4 (7628)	0.099mm	4.2		
4	Bottom Layer		0.035mm		GBL	
	Bottom Solder	Solder Resist	0.010mm	3.5	GBS	
	Bottom Overlay				GBO	

Total board thickness:

1.589mm

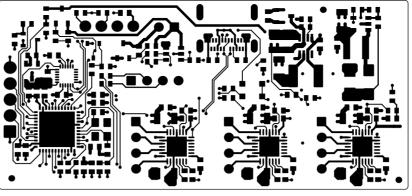


Symbol	Count	Hole Size	Hole Length	Plated	Hole Type	Drill Layer Pair	Via/Pad	Pad Shape
Ħ	253	0.200mm (7.87mil)	-	PTH	Round	Top Layer - Bottom Layer	Via	Rounded
❖	2	0.600mm (23.62mil)	1.600mm (62.99mil)	РТН	Slot	Top Layer - Bottom Layer	Pad	Rounded
	2	0.600mm (23.62mil)	2.100mm (82.68mil)	РТН	Slot	Top Layer - Bottom Layer	Pad	Rounded
0	18	1.000mm (39.37mil)	-	PTH	Round	Top Layer - Bottom Layer	Pad	(Mixed)
▽	4	1.200mm (47.24mi l)	-	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded
	279 Total							

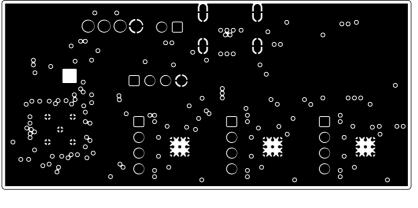
Slot definitions: Routed Path Length = Calculated from tool start centre position to tool end centre position.

Hole Length = Routed Path Length + Tool Size = Slot length as defined in the PCB layout





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